

# APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	[STRUCTURE OF THIN-FILM TRANSISTOR AND METHOD AND EQUIPMENT FOR FABRICATING THE STRUCTURE]
Application Type :	regular, utility
Attorney Docket Number :	11340-US-PA
Correspondence address:	
Customer Number:	31561
	
Priority Data:	
Doc.No: 2003-164366; Country -JP ; Date: 2003-05-07 us-priority-claimed	
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